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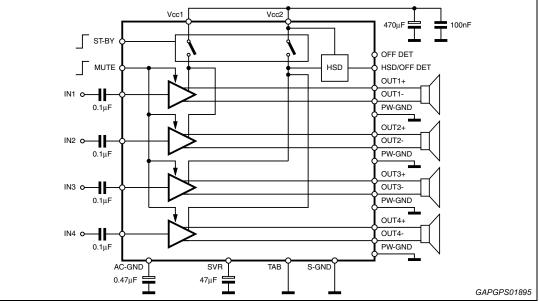
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1 Block diagram and application circuit

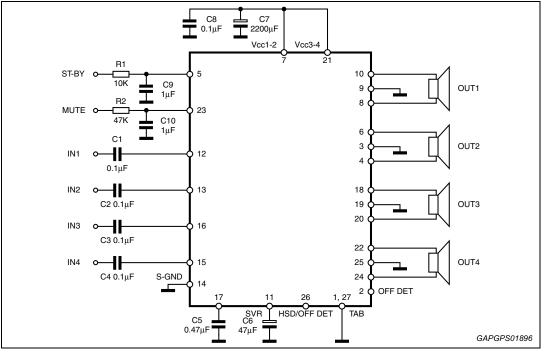
1.1 Block diagram

Figure 1. Block diagram



1.2 Standard test and application circuit

Figure 2. Standard test and application circuit



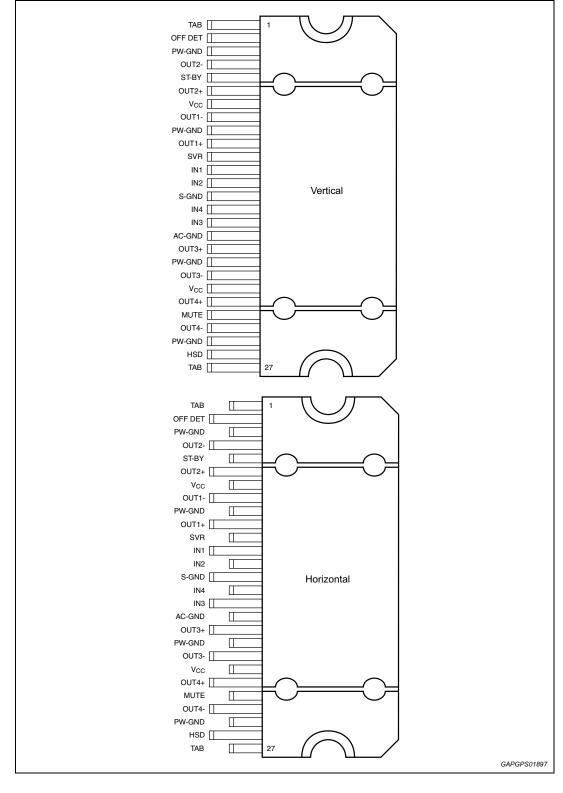


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2 Pin description







3 Electrical specifications

3.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _S	Operating supply voltage	18	V
V _{S (DC)}	DC supply voltage	28	V
V _{S (pk)}	Peak supply voltage (for t = 50 ms)	50	V
Ι _Ο	Output peak current repetitive (duty cycle 10 % at f = 10 Hz) non repetitive (t = 100 μ s)	9 10	A A
P _{tot}	Power dissipation $T_{case} = 70 \ ^{\circ}C$	80	W
Тј	Junction temperature	150	°C
T _{stg}	Storage temperature	-55 to 150	°C

3.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{th j-case}	Thermal resistance junction-to-case Max.	1	°C/W

3.3 Electrical characteristics

Refer to the test and application diagram, V_S = 14.4 V; R_L = 4 Ω ; R_g = 600 Ω ; f = 1 kHz; T_{amb} = 25 °C; unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
l _{q1}	Quiescent current	$R_L = \infty$	100	180	280	mA
V _{OS}	Output offset voltage	Play mode - Mute mode	-	-	±50	mV
dV _{OS}	During mute ON/OFF output offset voltage	ITU R-ARM weighted see <i>Figure 18</i>	-10	-	+10	mV
	During St-By ON/OFF output offset voltage		-10	-	+10	mV
G _v	Voltage gain	-	25	26	27	dB
dG _v	Channel gain unbalance	-	-	-	±1	dB



Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
Po	Output power	$V_{S} = 13.2 \text{ V}; \text{ THD} = 10 \%$ $V_{S} = 13.2 \text{ V}; \text{ THD} = 1 \%$ $V_{S} = 14.4 \text{ V}; \text{ THD} = 10 \%$ $V_{S} = 14.4 \text{ V}; \text{ THD} = 1 \%$	23 16 28 20	25 19 30 23	-	W
		$V_{\rm S}$ = 14.4 V; THD = 10 %, 2 Ω	50	55		W
P _{o max.}	Max. output power ⁽¹⁾	$V_{S} = 14.4$ V; $R_{L} = 4$ Ω $V_{S} = 14.4$ V; $R_{L} = 2$ Ω	-	50 85	-	W
THD	Distortion	$P_{o} = 4 W$ $P_{o} = 15 W; R_{L} = 2 Ω$	-	0.006 0.015	0.02 0.03	%
e _{No}	Output noise	"A" Weighted Bw = 20 Hz to 20 kHz	-	35 50	50 70	μV
SVR	Supply voltage rejection	f = 100 Hz; V _r = 1 Vrms	50	75	-	dB
f _{ch}	High cut-off frequency	P _O = 0.5 W	100	300	-	KHz
R _i	Input impedance		80	100	120	KΩ
C _T	Cross talk	$f = 1 \text{ kHz}; P_0 = 4 \text{ W}$ $f = 10 \text{ kHz}; P_0 = 4 \text{ W}$	60 -	70 60	-	dB
	Standby current consumption	V _{ST-BY} = 1.5 V	-	-	20	μΑ
I _{SB}		V _{ST-BY} = 0V	-	-	10	
I _{pin5}	Standby pin current	V _{ST-BY} = 1.5V to 3.5V	-	-	±1	μA
V _{SB out}	Standby out threshold voltage	(Amp: ON)	2.75	-	-	V
$V_{\text{SB in}}$	Standby in threshold voltage	(Amp: OFF)	-	-	1.5	V
A _M	Mute attenuation	P _{Oref} = 4W	80	90	-	dB
V _{M out}	Mute out threshold voltage	(Amp: Play)	3.5	-	-	V
V _{M in}	Mute in threshold voltage	(Amp: Mute)	-	-	1.5	V
V _{AM in}	V _S automute threshold	$\begin{array}{l} \mbox{(Amp: Mute)} \\ \mbox{Att} \geq 80 \mbox{ dB; } P_{Oref} = 4 \mbox{ W} \\ \mbox{(Amp: Play)} \end{array}$	6.5	7		V
		Att < 0.1 dB; P _O = 0.5 W		7.5	8	
I _{pin23}	Muting pin current	V _{MUTE} = 1.5 V (Sourced Current)	7	12	18	μA
		V _{MUTE} = 3.5 V	-5	-	18	μA
HSD sect	ion					
V _{dropout}	Dropout voltage	$I_0 = 0.35 \text{ A}; V_S = 9 \text{ to } 16 \text{ V}$	-	0.25	0.6	V
I _{prot}	Current limits	-	400	-	800	mA

 Table 4.
 Electrical characteristics (continued)



Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
Offset de	Offset detector (Pin 26)						
V _{M_ON}	Mute voltage for DC offset	V _{ST-BY} = 5 V	8	-	-	V	
V _{M_OFF}	detection enabled		-	-	6	V	
V _{OFF}	Detected differential output offset	V _{ST-BY} = 5 V; V _{mute} = 8 V	±2	±3	±4	V	
V _{26_T}	Pin 26 voltage for detection = TRUE	$V_{ST-BY} = 5 V; V_{mute} = 8 V$ $V_{OFF} > \pm 4 V$	0	-	1.5	V	
V _{26_F}	Pin 26 voltage for detection = FALSE	$V_{ST-BY} = 5 V; V_{mute} = 8 V$ $V_{OFF} > \pm 2 V$	12	-	-	V	

Table 4. Electrical characteristics (continued)

1. Saturated square wave output.

3.4 Electrical characteristic curves



Figure 5. Output power vs. supply voltage $(R_L = 4 \Omega)$

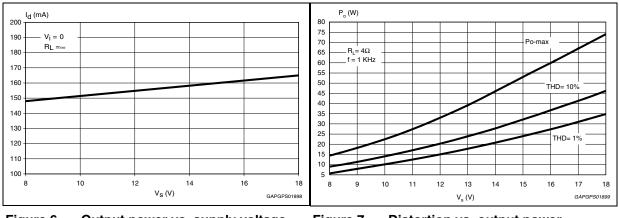
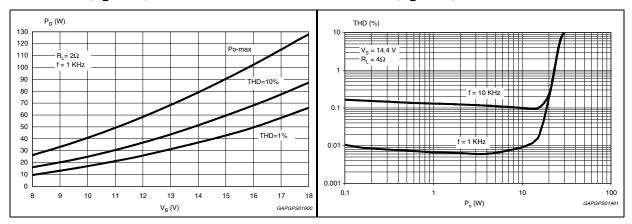
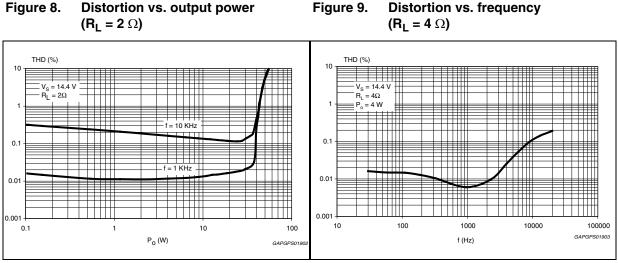


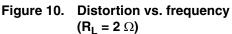
Figure 6. Output power vs. supply voltage $(R_L = 2 \Omega)$

Figure 7. Distortion vs. output power ($R_L = 4 \Omega$)









10

0.1

0.01

0.001



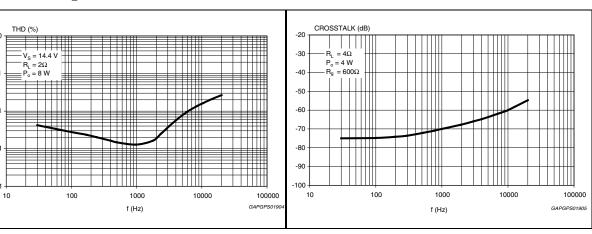
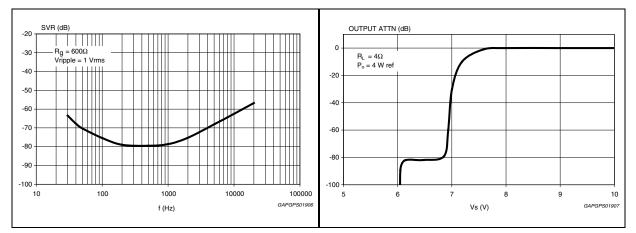


Figure 12. Supply voltage rejection vs. frequency

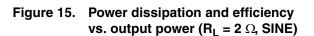
Figure 13. Output attenuation vs. supply voltage



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Figure 14. Power dissipation and efficiency vs. output power (R_L = 4 Ω , SINE)



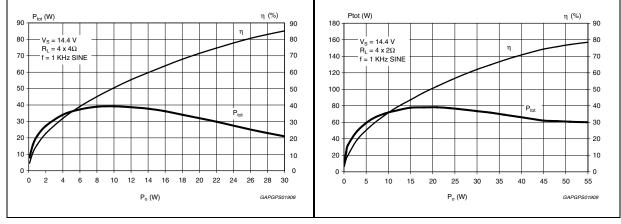


Figure 16. Power dissipation vs. output power Figure 17. Power dissipation vs. output power $(R_L = 4\Omega, audio program simulation)$ $(R_L = 2\Omega, audio program simulation)$

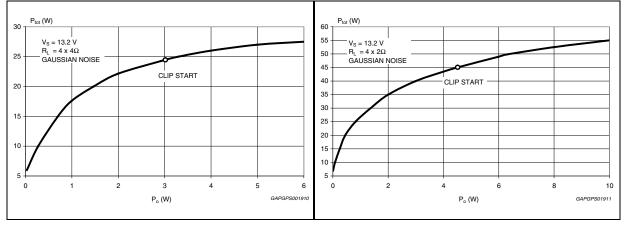
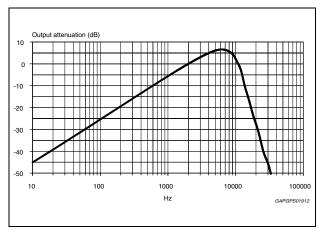


Figure 18. ITU R-ARM frequency response, weighting filter for transient pop





4 Application hints

Ref. to the circuit of *Figure 2*.

4.1 SVR

Besides its contribution to the ripple rejection, the SVR capacitor governs the turn ON/OFF time sequence and, consequently, plays an essential role in the pop optimization during ON/OFF transients. To conveniently serve both needs, **Its minimum recommended value is 10µF**.

4.2 Input stage

The TDA7850A's inputs are ground-compatible and can stand very high input signals $(\pm 8Vpk)$ without any performance degradation.

If the standard value for the input capacitors (0.1 μ F) is adopted, the low frequency cut-off will amount to 16 Hz.

4.3 Standby and muting

STANDBY and MUTING facilities are both CMOS compatible. In absence of true CMOS ports or microprocessors, a direct connection to Vs of these two pins is admissible but a 470k Ω equivalent resistance should be present between the power supply and the muting and stand-by pins.

R-C cells have always to be used in order to smooth down the transitions for preventing any audible transient noises.

About the stand-by, the time constant to be assigned in order to obtain a virtually pop-free transition has to be slower than 2.5V/ms.

4.4 DC offset detector

The TDA7850A integrates a DC offset detector to avoid that an anomalous DC offset on the inputs of the amplifier may be multiplied by the gain and result in a dangerous large offset on the outputs which may lead to speakers damage for overheating.

The feature works with the amplifier unmuted and no signal at the inputs.

The DC offset detection can be available at 2 different pins:

- Pin 2 (always enabled)
- Pin 26. Only enabled if Vmute (pin23) is set higher than 8V. If not (Vmute < 6 V) pin 26 will revert to the original HSD function.

4.5 Heatsink definition

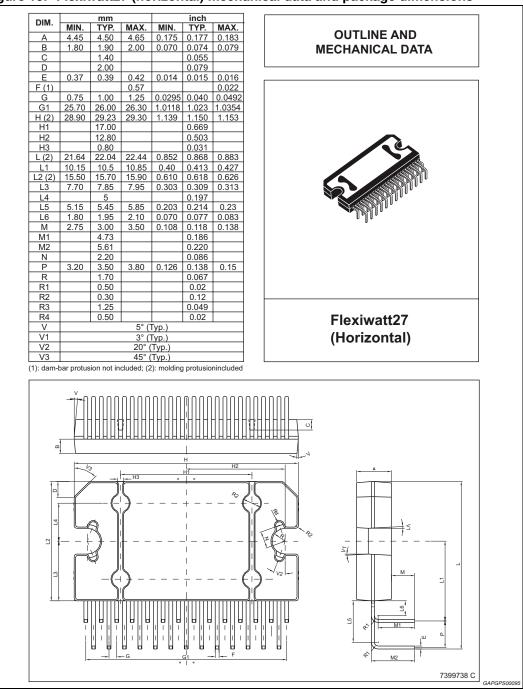
Under normal usage (4 Ohm speakers) the heatsink's thermal requirements have to be deduced from *Figure 16*, which reports the simulated power dissipation when real music/speech programmes are played out. Noise with gaussian-distributed amplitude was employed for this simulation. Based on that, frequent clipping occurrence (worst-case) will cause $P_{diss} = 26W$. Assuming $T_{amb} = 70^{\circ}C$ and $T_{CHIP} = 150^{\circ}C$ as boundary conditions, the heatsink's thermal resistance should be approximately $2^{\circ}C/W$. This would avoid any thermal shutdown occurrence even after long-term and full-volume operation.



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*.

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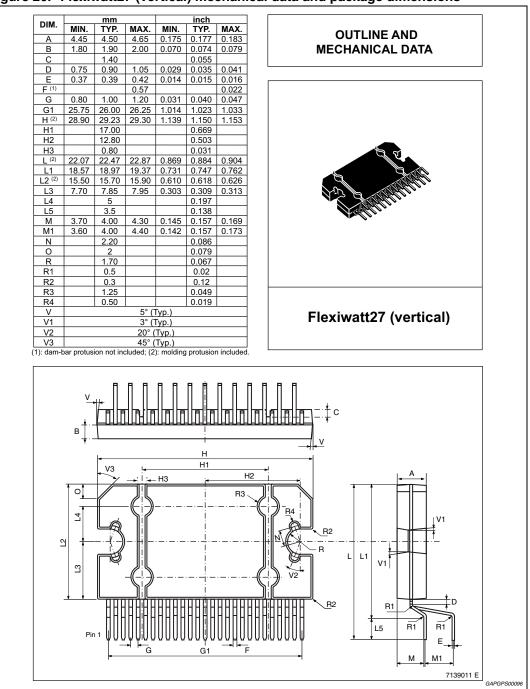


Figure 20. Flexiwatt27 (vertical) mechanical data and package dimensions



6 Revision history

Table 5.Document revision history

Date	Revision	Changes
09-Oct-2007	1	Initial release.
12-Sep-2008	2	Updated the values of V _{OS} and THD parameters on the <i>Table 4</i> .
07-Nov-2008	3	Modified max. values of the THD distortion in <i>Table 4: Electrical characteristics</i> on page 8.
14-Aug-2012	4	Updated Section 5: Package information.
17-Sep-2013	5	Updated Disclaimer.



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